

#### FEATURES

- 0.56 inch (14.2 mm) Digit Height.
- SMD type.
- Low current operation.
- Gray face, White segment.
- RoHS compliant, Pb Free.

#### DESCRIPTION

The SMA562LB G/W & SMC562LB G/W are 0.56 inch (14.2mm) height Dual 7-segment displays.

This device utilizes Super Bright Blue LED chip which are made from InGaN On a transparent GaN, substrate.

The display has Gray face, White segment.

## DEVICE

PART NO	DESCRIPTION		
SMA562LB G/W	Common Anode		
SMC562LB G/W	Common Cathode		

# **RoHS Compliance**

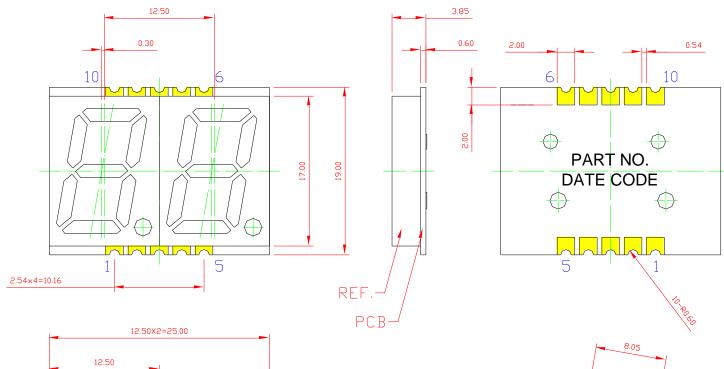


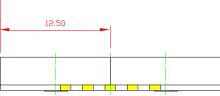
## Pb free.





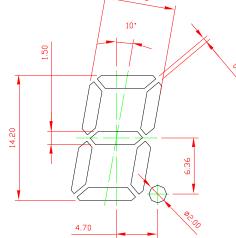
### MECHANICAL DIMENSIONS





## NOTE:

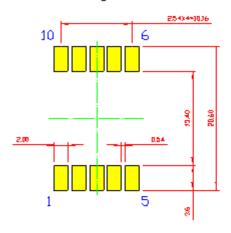
Dimension in millimeters (inches), And tolerance are  $\pm\,0.25\text{mm}$  (.01") specified.



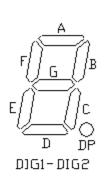


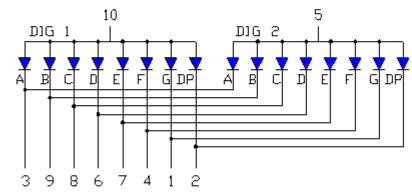
# TYPICAL INTERNAL EQUIVALENT CIRCUIT

Recommended Soldering Pattern

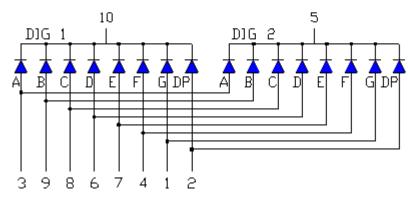








(Common Anode)



(Common Cathode)

Revision 3.0

American Opto. Plus LED Corp. 1206 E. Lexington Ave, Pomona Ca 91766 Website: www.aopled.com Tel: 909-465-0080 Fax: 909-465-0130



# SUPER BRIGHT BLUE (InGaN/GaN)

#### ABSOLUTE MAXIMUM RATING AT Ta=25°C

Parameter	Symbol	Maximum Rating	Unit	
Power dissipation	P <sub>AD</sub>	120	mW	
Derating liner from 25°C	-	0.3	mA / °C	
Continuous forward current	I <sub>AF</sub>	30	mA	
Peak current (duty cycle 1/10, 1kHz)	I <sub>PF</sub>	100	mA	
Reverse voltage	$V_{R}$	5	V	
Operating temperature	T <sub>OPR</sub>	-40 to +105	°C	
Storage temperature	T <sub>STG</sub>	-40 to +105	°C	

#### ELECTRICAL - OPTICAL CHARACTERISTICS AT Ta=25°C

Characteristic	Symbol	Condition	Min.	Type.	Max.	Unit
Forward Voltage, (Per Dice)	$V_{F}$	I <sub>F</sub> =20mA	-	3.2	4.0	٧
Reverse Current, (Per Dice)	I <sub>R</sub>	V <sub>R</sub> =8V	-	-	10	μA
Dominant Wavelength	$\lambda_{D}$	I <sub>F</sub> =20mA	-	470	-	nm
Luminous Intensity	I <sub>V</sub>	I <sub>F</sub> =20mA	-	30	-	mcd
Spectral radiation bandwidth	Δλ	I <sub>F</sub> =20mA	-	30	-	nm

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## SUPER BRIGHT BLUE (InGaN/GaN) CURVE

# Typical Electro-optical Characteristic Curves (25 °C Free Air Temperature Unless Otherwise Specified)

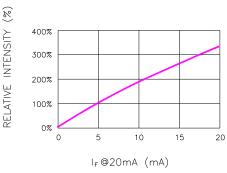
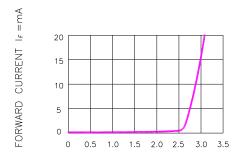
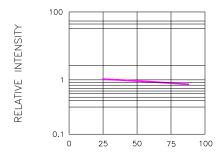


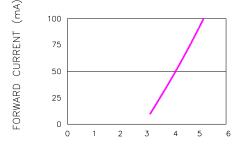
Fig.1 RELATIVE INTENSITY VS. FORWARD CURRENT



FORWARD VOLTAGE (V)
Fig.2 FORWARD CURRENT VS. FORWARD VOLTAGE



LEAD TEMPERATURE(\*C)
Fig.3 RELATIVE INTENSITY VS.LEAD TEMPERATURE
(PULSED 20 mA; 300us
PULSE,10ms PERIOD)



FORWARD VOLTAGE(V)
Fig.4 PEAK FORWARD VOLTAGE
VS.FORWARD(100us TEST PULSE,
1% DUTY CYCLE)

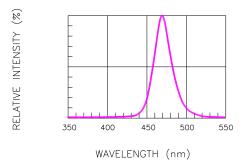
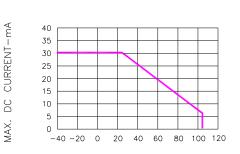


Fig.5 RELATIVE INTENSITY VS. WAVELENGTH



AMBIENT TEMPERATURE (TA)-°C

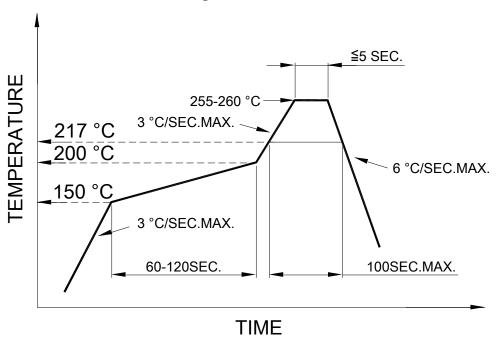
Fig.6 MAX. ALLOWABLE DC CURRENT VS. AMBIENT TEMPERATURE



#### RECOMMEND SOLDERING PROFILE

SMT Soldering Profile

Pb free reflow soldering Profile



## SOLDERING IRON

Basic specification : ≦4 seconds when 260°C, If temperature is higher, time should be shorter (+10°C→1 sec). Power dissipation of iron should be smaller than 15W, and temperature should be controllable. Surface temperature of the device should be under 230°C.

## REWORK

Customer must finish rework within ≦3 sec under 350°C.

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